High Current & Voltage Cartridge Fuses

Lead-free > 10x32mm Fuse > 607 Series











Agency Approvals

Agency	Agency File Number	Ampere Range	
c 'Al os	E71611	40 A to 63 A	
A	J 50514752	40 A to 63 A	

Electrical Characteristics

% of Ampere Rating	Ampere Rating	Opening Time at 25°C
100%	40 A to 63 A	4hrs, Min.
200%	40 A to 63 A	120 seconds, Max.

Description

The 607 series fuses are specifically designed and tested to cater to the circuit protection needs of compact applications, which is 500Vdc/Vac rated with remarkable interrupting rating.

Features

- RoHS compliant and Lead-free
- High Interrupt Rating
- Rated voltage 500 Vdc/Vac

Benefits

- Small size
- High current
- High voltage
- High breaking capacity

Applications

- Data Center Power Supplies
- Uninterruptible Power Supply (UPS)
- Power conversion equipment like inverters and rectifiers

Additional Information







Resources

Accessories

Samples

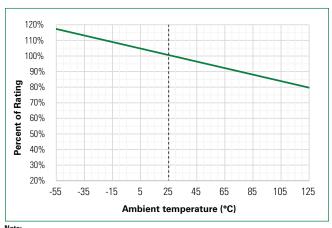
Electrical Specifications

Ampere Rating	Amp	Max Voltage Rating	Interrupting Rating	Nominal Code Resistance	Nominal Melting	Agency Approvals	
(A)	Code	ode (V) (AC/DC) (Ohm)		I ² t (A ² sec)	c '%\ us	A	
40	040.	500VDC	10KA@500VDC 10KA@500VAC	0.00187	2570	×	X
50	050.	500VAC		0.00145	4230	×	X
63	063.	500VDC 500VAC 300VAC	10KA@500VDC 5KA@500VAC 10KA@300VAC	0.00102	7060	Х	Х

Unless otherwise stated, all specifications are referenced at room ambient temperature.

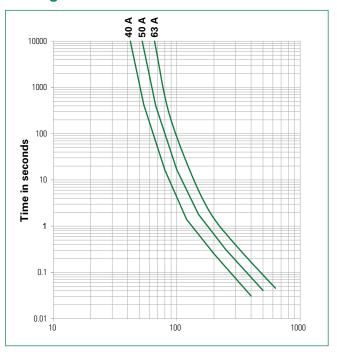
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Temperature Re-rating Curve



Note: Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

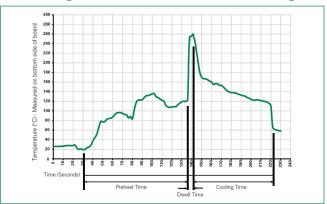
Average Time Current Curves



Product Characteristics

Materials	Body: Glass fiber Cap: Ni plated copper alloy Terminal: Tin plated copper alloy			
Mechanical Shock	MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 milliseconds)			
Solderability	Reference MIL-STD-202 method 208			
Product Marking	Cap 1: Brand logo, current and voltage ratings Cap 2: Agency approval marks			
Resistance to Solder Heat	MIL-Std 202 Method 210 Test Condition B (10sec at 260 °C)			
Operating Temperature	-55 °C to +125 °C			
Thermal Shock	MIL-STD-202G, Method 107G, Test condition B			
Vibration	MIL-STD-202G, Method 201A			
Moisture Resistance	MIL-STD-202G, Method 103B, Test condition A			
Salt Spray	MIL-STD-202G, Method 101E, Test condition B			

Soldering Parameters-Wave Soldering



Wave Parameter	Lead-Free Recommendation	
Preheat: (Depends on Flex Activation Temperature)	(Typical Industry Recommendation)	
Temperature Minimum	100 °C	
Temperature Maximum	150 °C	
Preheat Time	60-180 seconds	
Solder Pot Temperature	260 °C Maximum	
Solder Dwell Time	2-5 seconds	

Recommended Hand-Solder Parameters:

Solder Iron Temperature: 350 °C +/- 5 °C

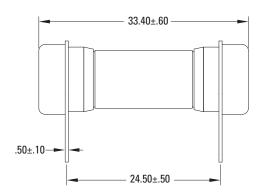
Heating Time: 5 seconds max.

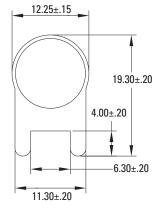
Note: These devices are not recommended for IR or Convection Reflow process.



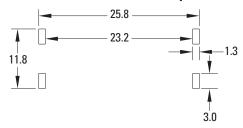
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Dimensions



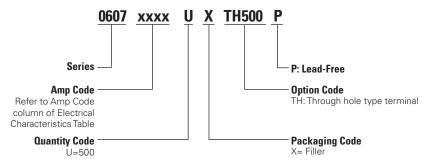


Recommended PCB Layout



All dimensions in mm

Part Numbering System



Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code	Reel Size	
607 Series					
Tray	NA	500	NA	NA	

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